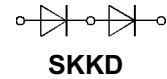


## SEMIPACK® 3 Rectifier Diode Modules

### SKKD 260



$V_{RSM}$	$V_{RRM}$	$I_{FRMS}$ (maximum values for continuous operation)
		410 A
		$I_{TAV}$ (sin. 180; $T_{case} = 85\text{ °C}$ )
V	V	260 A
900	800	<b>SKKD 260/08</b>
1300	1200	<b>SKKD 260/12</b>
1500	1400	<b>SKKD 260/14</b>
1700	1600	<b>SKKD 260/16</b>
2100	2000	<b>SKKD 260/20 H4<sup>3)</sup></b>
2300	2200	<b>SKKD 260/22 H4<sup>3)</sup></b>

Symbol	Conditions	SKKD 260	Units	
$I_{FAV}$	sin. 180; $T_{case} = 85\text{ °C}$	260	A	
$I_D$	B2/B6			
	$T_{amb} = 35\text{ °C}$ ;	280 / 320	A	
	P 3/180 F	490 / 655	A	
$I_{FSM}$	$T_{vj} = 25\text{ °C}$ ; 10 ms	11 000	A	
	$T_{vj} = 130\text{ °C}$ ; 10 ms	10 000	A	
$i^2t$	$T_{vj} = 25\text{ °C}$ ; 8,3 ... 10 ms	605 000	A <sup>2</sup> s	
	$T_{vj} = 130\text{ °C}$ ; 8,3 ... 10 ms	500 000	A <sup>2</sup> s	
$I_{RD}$	$T_{vj\ max.}$ ; $V_{RD} = V_{RRM}$	15	mA	
$V_F$	$T_{vj} = 25\text{ °C}$ ; $I_F = 750\text{ A}$	max. 1,25	V	
$V_{(TO)}$	$T_{vj} = 130\text{ °C}$	0,90	V	
$r_T$	$T_{vj} = 130\text{ °C}$	0,37	mΩ	
$R_{thjc}$	cont.	per diode / per module	0,14 / 0,07	°C/W
	sin. 180	per diode / per module	0,15 / 0,075	°C/W
$R_{thch}$		per diode / per module	0,04 / 0,02	°C/W
$T_{vj}$		- 40 ... + 130	°C	
$T_{stg}$		- 40 ... + 130	°C	
$V_{isol}$	a. c. 50 Hz; r.m.s.; 1 s/1 min	3600 / 3000	V~	
$M_1$	to heatsink	SI units	$5 \pm 15\%$ <sup>1)</sup>	Nm
		US units	$44 \pm 15\%$ <sup>1)</sup>	lb.in.
$M_2$	to terminals	SI units	$9 \pm 15\%$ <sup>2)</sup>	Nm
		US units	$80 \pm 15\%$ <sup>2)</sup>	lb.in.
a			$5 \cdot 9,81$	m/s <sup>2</sup>
w	approx.		750	g
Case			A 78a	

#### Features

- Heat transfer through aluminium nitride ceramic isolated metal baseplate
- Precious metal pressure contacts
- UL recognized, file no. E 63 532

#### Typical Applications

- Non-controllable rectifiers for AC/AC converters
- Line rectifiers for transistorized AC motor controllers
- Field supply for DC motors

<sup>1)</sup> See the assembly instructions

<sup>2)</sup> The screws must be lubricated

<sup>3)</sup> Visol 1 s/ 1 min. = 4800/4000 V~

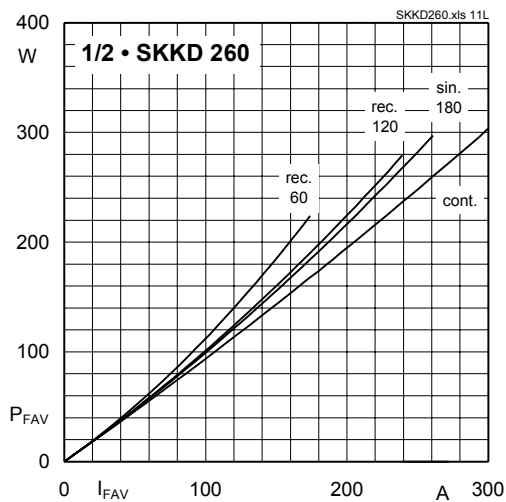


Fig. 11L Power dissipation per diode vs. on-state current

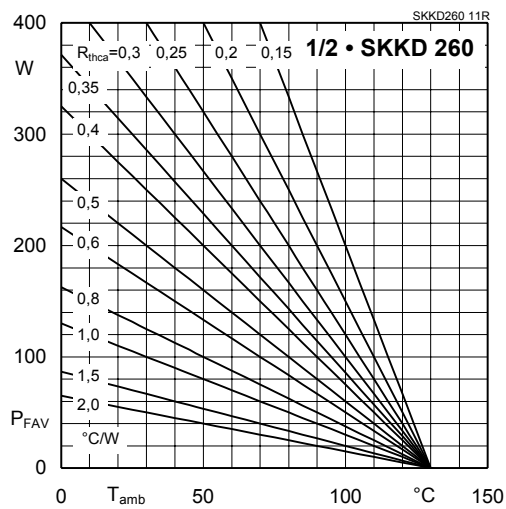


Fig. 11R Power dissipation per diode vs. ambient temp.

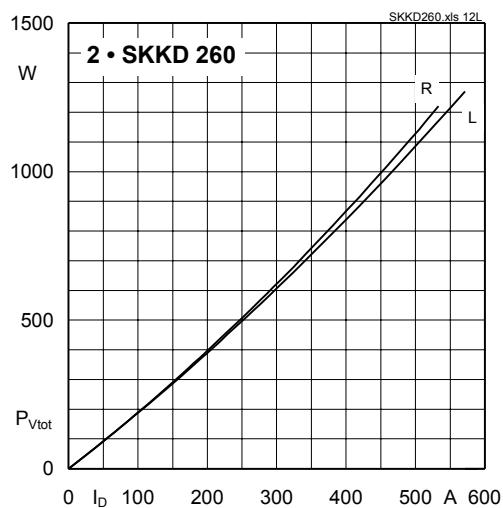


Fig. 12L Power dissipation of two modules vs. rms current

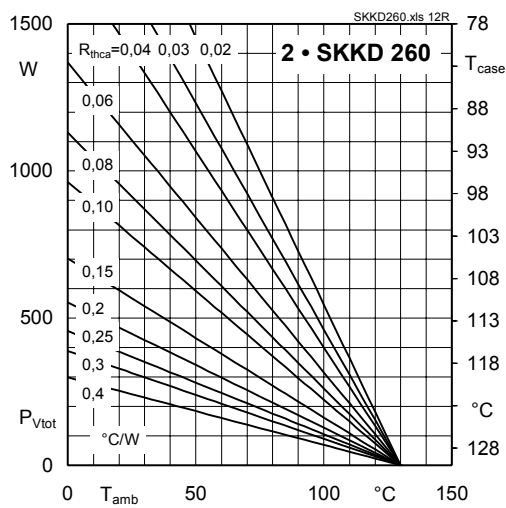


Fig. 12R Power dissipation of two modules vs. case temp.

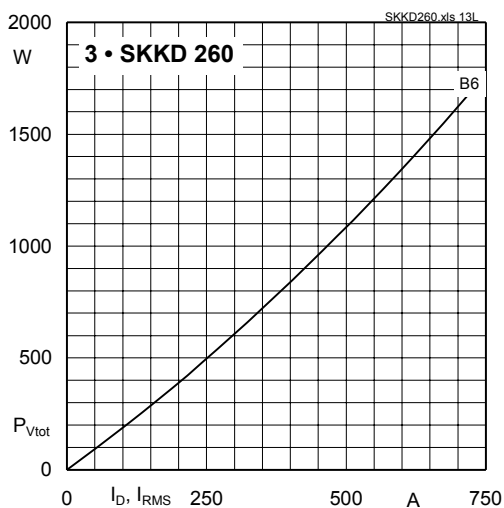


Fig. 13L Power dissipation of three modules vs. direct current

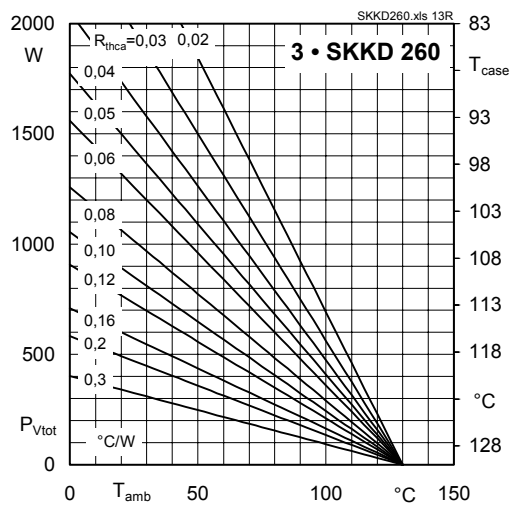


Fig. 13R Power dissipation of three modules vs. case temp.

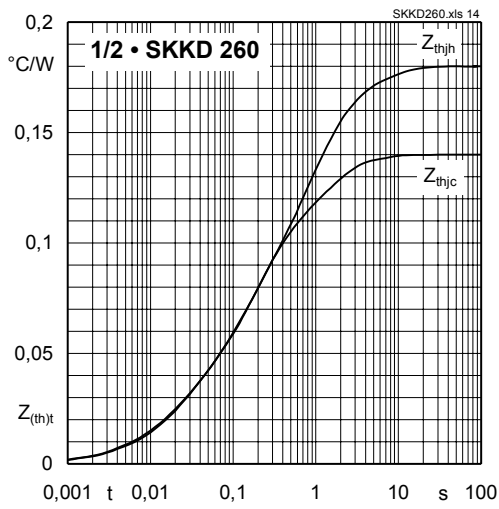


Fig. 14 Transient thermal impedance vs. time

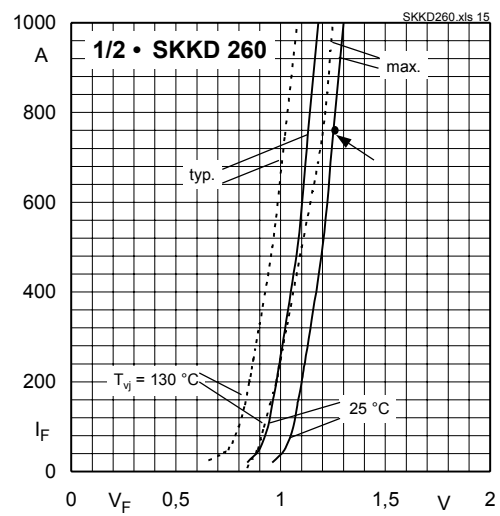


Fig. 15 Forward characteristics

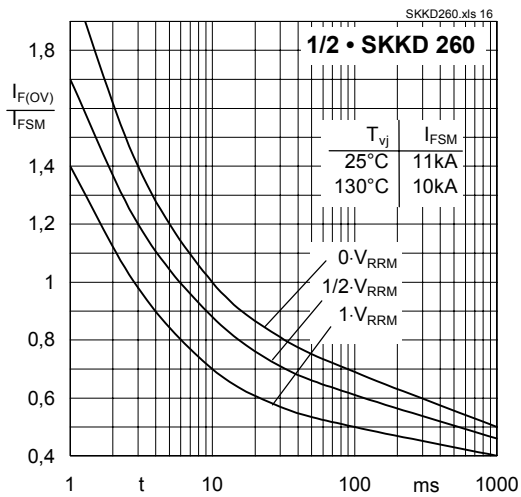
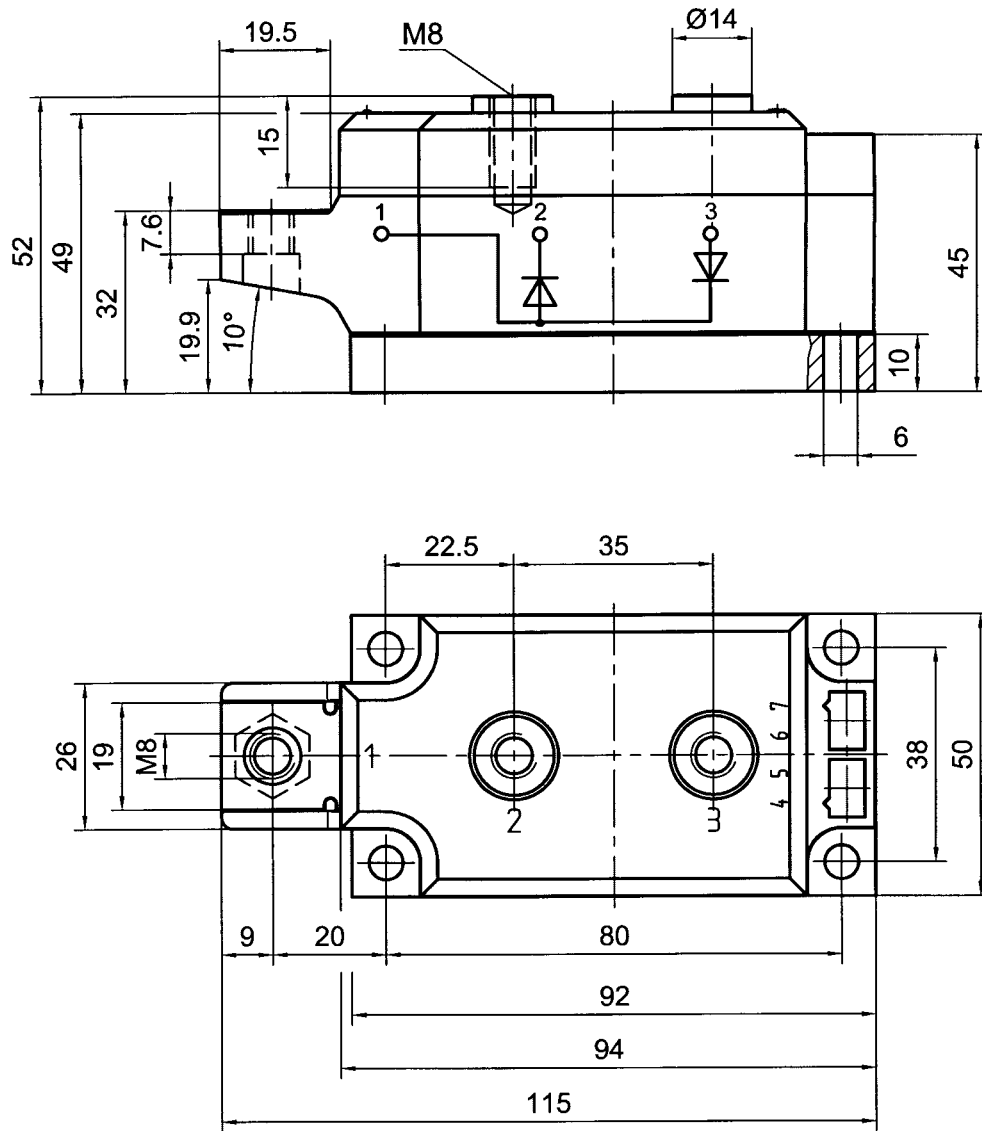


Fig. 16 Surge overload current vs. time

**SKKD 260**

Case A 78 a  
SEMIPACK® 3

UL recognition, file no. E 63 532



Dimensions in mm